

**Amendments to the Claims**

The following listing of the claims replaces all previous amendments and listings of the claims.

1. (Previously Presented) A power semiconductor module, comprising:

an electrode terminal connected with an electric power semiconductor device which is resin sealed inside of a case at one end while having a hole and exposed along a side of an outer surface of the case at the other end;

an electrode plate for external connection having a hole and arranged to overlie said electrode terminal on an outer surface of the case;

a female screw hole provided on the outer surface of the case so as to correspond to said hole of the electrode terminal; and

a male screw member having screw threads disposed on both ends, penetrating through said hole of said electrode terminal and engaging threadedly with the female screw hole at one end while projecting from the upper surface of the electrode terminal at the other end,

wherein said electrode plate for external connection is electrically connected with said electrode terminal on the outer surface of the case by placing said electrode plate so that the male screw member passes through said hole of the electrode plate, and then engaging a nut with the male screw member.

2. (Original) The power semiconductor module according to claim 1, wherein a nut having the female screw hole is embedded in the outer surface of the case, and the nut is fixed to a lower surface of the electrode terminal.

3. (Previously Presented) The power semiconductor module according to claim 1, wherein said electrode terminal includes said female screw hole.

4. (Previously Presented) The power semiconductor module according to claim 1, wherein said male screw member includes different nominal diameters at opposite ends.

5. (Previously Presented) The power semiconductor module according to claim 1, wherein said male screw member includes threads at opposite ends of which thread directions are opposite from each other.

6. (Original) The power semiconductor module according to claim 1, wherein at least one nut is fixed to a middle portion of said male screw member.

7. (Currently Amended) The power semiconductor module according to ~~any one of~~ claim 1, wherein a middle portion of said male screw member is formed with a discontinuous portion having no screw thread.

8. (Original) The power semiconductor module according to claim 1, wherein said male screw member is threadedly engaged with said female screw hole through a plurality of electrode terminals.